

# PE42542

## Product Specification

UltraCMOS® SP4T RF Switch, 9 kHz–18 GHz



## Features

- HaRP™ technology enhanced:
  - Fast settling time
  - No gate or phase lag
  - No drift in insertion loss or phase
- Low insertion loss:
  - 1.10 dB at 3 GHz
  - 2.10 dB at 13.5 GHz
  - 2.50 dB at 16 GHz
  - 3.10 dB at 18 GHz
- High isolation:
  - 55 dB at 3 GHz
  - 33 dB at 13.5 GHz
  - 29 dB at 16 GHz
  - 26 dB at 18 GHz
- ESD performance:
  - 2500V HBM on all pins
  - 150V MM on all pins
  - 500V CDM on all pins
- Packaging: 29-lead 4 × 4 mm LGA

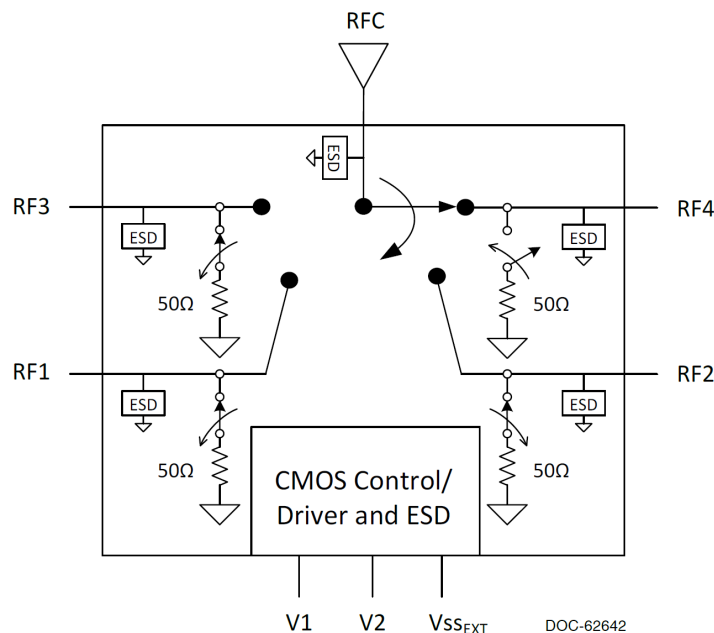


Figure 1. PE42542 functional block diagram

## Product description

The PE42542 is a HaRP™ technology-enhanced absorptive SP4T RF switch designed for use in test and measurement, automated test equipment (ATE), microwave, and other wireless applications. This broadband general-purpose switch maintains excellent RF performance and linearity from 9 kHz through 18 GHz. The PE42542 exhibits low insertion loss, high isolation performance, and has fast settling time. No blocking capacitors are required if no DC voltage is present on the RF ports.

The PE42542 is manufactured using the pSemi UltraCMOS® process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate.

pSemi's HaRP technology enhancements deliver high linearity and excellent harmonics performance. It is an innovative feature of the UltraCMOS process, offering the performance of GaAs with the economy and integration of conventional CMOS.

## Absolute maximum ratings

Exceeding the absolute maximum ratings listed in Table 1 could cause permanent damage. Restrict operation to the limits in Table 2. Operation between the operating range maximum and the absolute maximum for extended periods could reduce reliability.

## ESD precautions

When handling this UltraCMOS device, observe the same precautions as with any other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, do not exceed the rating listed in Table 1.

## Latch-up immunity

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

Table 1. Absolute maximum ratings

| Parameter or condition                                                                             | Symbol           | Min  | Max                | Unit |
|----------------------------------------------------------------------------------------------------|------------------|------|--------------------|------|
| Supply voltage                                                                                     | $V_{DD}$         | -0.3 | 5.5                | V    |
| Digital input voltage (V1, V2)                                                                     | $V_{CTRL}$       | -0.3 | 3.6                | V    |
| RF input power, CW (RFC–RFx) <sup>(3)</sup><br>9 kHz–2.9 MHz<br>≥ 2.9 MHz–18 GHz                   | $P_{MAX,CW}$     | –    | See Figure 2<br>33 | dBm  |
| RF input power, pulsed (RFC–RFx) <sup>(4)</sup><br>9 kHz–2.9 MHz<br>≥ 2.9 MHz–18 GHz               | $P_{MAX,PULSED}$ | –    | See Figure 2<br>34 | dBm  |
| RF input power into terminated ports, CW (RFx) <sup>(3)</sup><br>9 kHz–1.4 MHz<br>≥ 1.4 MHz–18 GHz | $P_{MAX,TERM}$   | –    | See Figure 2<br>22 | dBm  |
| Storage temperature range                                                                          | $T_{ST}$         | -65  | +150               | °C   |
| ESD voltage HBM, all pins <sup>(3)</sup>                                                           | $V_{ESD,HBM}$    | –    | 2500               | V    |
| ESD voltage MM, all pins <sup>(4)</sup>                                                            | $V_{ESD,MM}$     | –    | 150                | V    |
| ESD voltage CDM, all pins <sup>(5)</sup>                                                           | $V_{ESD,CDM}$    | –    | 500                | V    |

### Notes:

- 100% duty cycle, all bands, 50Ω
- Pulsed, 5% duty cycle of 4620-μs period, 50Ω
- Human Body Model (MIL\_STD 883 Method 3015)
- Machine Model (JEDEC JESD22-A115)
- Charged Device Model (JEDEC JESD22-C101)

## Recommended operating conditions

Table 2 lists the PE42542 recommended operating conditions. Do not operate devices outside the operating conditions listed below.

Table 2. Recommended operating conditions

| Parameter                                                                                                                                                                                                                                                                                                                                                                 | Symbol           | Min  | Typ | Max                | Unit    |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|------|-----|--------------------|---------|
| <b>Normal mode (<math>V_{SS\_EXT} = 0V</math>)<sup>(1)</sup></b>                                                                                                                                                                                                                                                                                                          |                  |      |     |                    |         |
| Supply voltage                                                                                                                                                                                                                                                                                                                                                            | $V_{DD}$         | 2.3  | –   | 5.5                | V       |
| Supply current                                                                                                                                                                                                                                                                                                                                                            | $I_{DD}$         | –    | 120 | 200                | $\mu A$ |
| <b>Bypass mode (<math>V_{SS\_EXT} = -3.4V</math>)<sup>(2)</sup></b>                                                                                                                                                                                                                                                                                                       |                  |      |     |                    |         |
| Supply voltage                                                                                                                                                                                                                                                                                                                                                            | $V_{DD}$         | 2.7  | 3.4 | 5.5                | V       |
| Supply current                                                                                                                                                                                                                                                                                                                                                            | $I_{DD}$         | –    | 50  | 80                 | $\mu A$ |
| Negative supply voltage                                                                                                                                                                                                                                                                                                                                                   | $V_{SS\_EXT}$    | -3.6 | –   | -3.2               | V       |
| Negative supply current                                                                                                                                                                                                                                                                                                                                                   | $I_{SS}$         | -40  | -16 | –                  | $\mu A$ |
| <b>Normal or bypass mode</b>                                                                                                                                                                                                                                                                                                                                              |                  |      |     |                    |         |
| Digital input high (V1, V2)                                                                                                                                                                                                                                                                                                                                               | $V_{IH}$         | 1.17 | –   | 3.6                | V       |
| Digital input low (V1, V2)                                                                                                                                                                                                                                                                                                                                                | $V_{IL}$         | -0.3 | –   | 0.6                | V       |
| RF input power, CW (RFC–RFx) <sup>(3)</sup><br>9 kHz–2.9 MHz<br>$\geq 2.9$ MHz–18 GHz                                                                                                                                                                                                                                                                                     | $P_{MAX,CW}$     | –    | –   | See Figure 2<br>30 | dBm     |
| RF input power, pulsed (RFC–RFx) <sup>(4)</sup><br>9 kHz–2.9 MHz<br>$\geq 2.9$ MHz–18 GHz                                                                                                                                                                                                                                                                                 | $P_{MAX,PULSED}$ | –    | –   | See Figure 2<br>32 | dBm     |
| RF input power into terminated ports, CW (RFx) <sup>(3)</sup><br>9 kHz–1.4 MHz<br>$\geq 1.4$ MHz–18 GHz                                                                                                                                                                                                                                                                   | $P_{MAX,TERM}$   | –    | –   | See Figure 2<br>20 | dBm     |
| Operating temperature range                                                                                                                                                                                                                                                                                                                                               | $T_{OP}$         | -40  | +25 | +85                | °C      |
| Notes:<br>1. Normal mode: Connect $V_{SS\_EXT}$ (pin 29) to GND ( $V_{SS\_EXT} = 0V$ ) to enable the internal negative voltage generator.<br>2. Bypass mode: Use $V_{SS\_EXT}$ (pin 29) to bypass and disable the internal negative voltage generator.<br>3. 100% duty cycle, all bands, 50 $\Omega$ .<br>4. Pulsed, 5% duty cycle of 4620- $\mu s$ period, 50 $\Omega$ . |                  |      |     |                    |         |

## Electrical specifications

Table 3 lists the PE42542 key electrical specifications at +25 °C ( $Z_S = Z_L = 50\Omega$ ), unless otherwise specified.

- Normal mode:  $V_{DD} = 3.3V$ ,  $V_{SS\_EXT} = 0V^{(1)}$
- Bypass mode:  $V_{DD} = 3.4V$ ,  $V_{SS\_EXT} = -3.4V^{(2)}$

Table 3. Electrical specifications

| Parameter                                     | Path    | Condition                                                                                                               | Min                                    | Typ                                                  | Max                                                  | Unit |
|-----------------------------------------------|---------|-------------------------------------------------------------------------------------------------------------------------|----------------------------------------|------------------------------------------------------|------------------------------------------------------|------|
| Operating frequency                           | –       | –                                                                                                                       | 9 k                                    | –                                                    | 18 G                                                 | Hz   |
| Insertion loss                                | RFC–RFx | 9 kHz–10 MHz<br>10–3000 MHz<br>3000–7500 MHz<br>7500–10000 MHz<br>10000–13500 MHz<br>13500–16000 MHz<br>16000–18000 MHz | –                                      | 0.70<br>1.10<br>1.50<br>1.75<br>2.10<br>3.10<br>3.90 | 0.90<br>1.40<br>1.95<br>2.20<br>2.40<br>3.50<br>4.50 | dB   |
| Isolation                                     | RFx–RFx | 9 kHz–10 MHz<br>10–3000 MHz<br>3000–7500 MHz<br>7500–10000 MHz<br>10000–13500 MHz<br>13500–16000 MHz<br>16000–18000 MHz | 80<br>53<br>46<br>42<br>35<br>30<br>26 | 90<br>55<br>48<br>44<br>37<br>31<br>27               | –                                                    | dB   |
| Isolation                                     | RFC–RFx | 9 kHz–10 MHz<br>10–3000 MHz<br>3000–7500 MHz<br>7500–10000 MHz<br>10000–13500 MHz<br>13500–16000 MHz<br>16000–18000 MHz | 80<br>54<br>41<br>36<br>31<br>27<br>24 | 90<br>55<br>42<br>38<br>33<br>29<br>26               | –                                                    | dB   |
| Return loss (active and common port)          | RFC–RFx | 9 kHz–10 MHz<br>10–3000 MHz<br>3000–18000 MHz                                                                           | –                                      | 35<br>15<br>13                                       | –                                                    | dB   |
| Return loss (terminated port)                 | RFx     | 9 kHz–18000 MHz                                                                                                         | –                                      | 16                                                   | –                                                    | dB   |
| Input 0.1 dB compression point <sup>(3)</sup> | RFC–RFx | –                                                                                                                       | –                                      | See <a href="#">Figure 2</a>                         | –                                                    | dBm  |
| Input IP2                                     | RFC–RFx | 10–18000 MHz                                                                                                            | –                                      | 118                                                  | –                                                    | dBm  |
| Input IP3                                     | RFC–RFx | 10–18000 MHz                                                                                                            | –                                      | 58                                                   | –                                                    | dBm  |
| Settling time                                 | –       | 50% CTRL to 0.05 dB final value                                                                                         | –                                      | 7                                                    | 10                                                   | μs   |
| Switching time <sup>(4)</sup>                 | –       | 50% CTRL to 90% or 10% of final value                                                                                   | –                                      | 3                                                    | 4.5                                                  | μs   |

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Path | Condition | Min | Typ | Max | Unit |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----------|-----|-----|-----|------|
| <p>Notes:</p> <ol style="list-style-type: none"><li>1. Normal mode: Connect <math>V_{SS\_EXT}</math> (pin 29) to GND (<math>V_{SS\_EXT} = 0V</math>) to enable the internal negative voltage generator.</li><li>2. Bypass mode: Use <math>V_{SS\_EXT}</math> (pin 29) to bypass and disable the internal negative voltage generator.</li><li>3. The input 0.1 dB compression point is a linearity figure of merit. For the RF input power <math>P_{MAX}</math> (50Ω), see <a href="#">Table 2</a>.</li><li>4. The PE42542 has a maximum 25 kHz switching rate when the internal negative voltage generator is used (pin 29 = GND). The switching frequency describes the time duration between switching events. The switching time is the duration between the point that the control signal reaches 50% of the final value and the point that the output signal reaches within 10% or 90% of its target value.</li></ol> |      |           |     |     |     |      |

## Optional external $V_{SS\_EXT}$ control ( $V_{SS\_EXT}$ )

For proper operation, the  $V_{SS\_EXT}$  control pin must be grounded or tied to the  $V_{SS}$  voltage specified in [Table 2](#). When the  $V_{SS\_EXT}$  control pin is grounded, the FETs in the switch are biased with an internal negative voltage generator. For applications that require the lowest possible spurious performance,  $V_{SS\_EXT}$  can be applied externally to bypass the internal negative voltage generator.

## Spurious performance

The PE42542 typical spurious performance is  $-150$  dBm when  $V_{SS\_EXT} = 0V$  (pin 29 = GND). To improve performance, disable the internal negative voltage generator by setting  $V_{SS\_EXT} = -3.4V$ .

## Control logic

Table 4. Truth table

| State  | V1 | V2 |
|--------|----|----|
| RF1 on | 0  | 0  |
| RF2 on | 1  | 0  |
| RF3 on | 0  | 1  |
| RF4 on | 1  | 1  |

## Hot switching

The PE42542 maximum hot switching capability is  $20$  dBm from  $1.4$  MHz to  $18$  GHz. The maximum hot switching capability below  $1.4$  MHz does not exceed the maximum RF CW terminated power shown in [Figure 2](#). Hot switching occurs when RF power is applied while switching between the RF ports.

Power derating curves

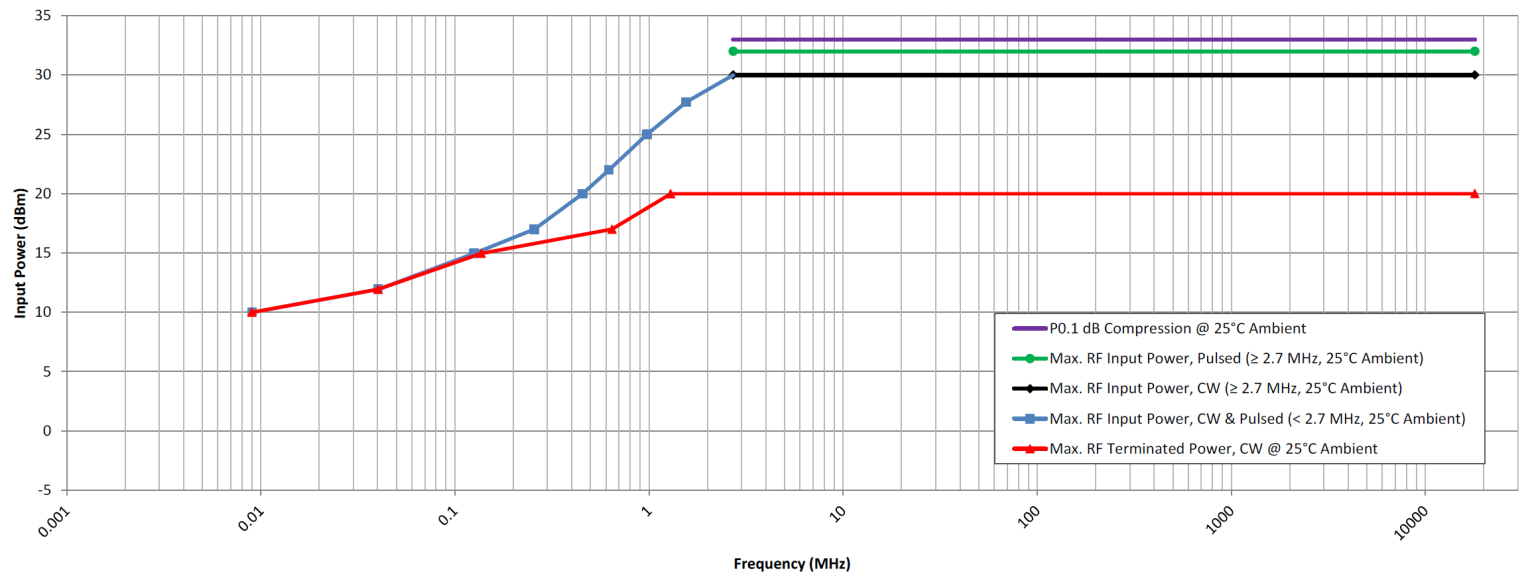


Figure 2. Power derating curve for 9 kHz–18 GHz at 25°C ambient (50Ω)

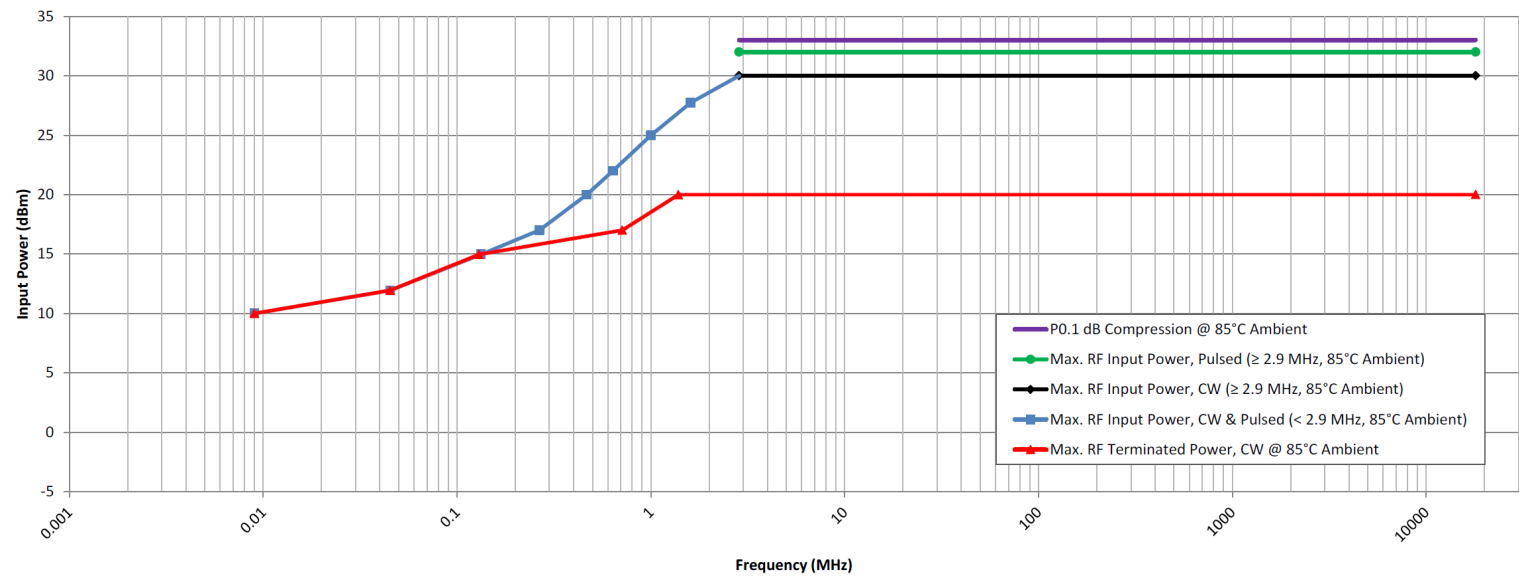


Figure 3. Power derating curve for 9 kHz–18 GHz at 85°C ambient (50Ω)

Typical performance data

Figures 4–18 show the typical performance data at +25 °C and  $V_{DD} = 3.3V$  ( $Z_S = Z_L = 50\Omega$ ), unless otherwise specified.

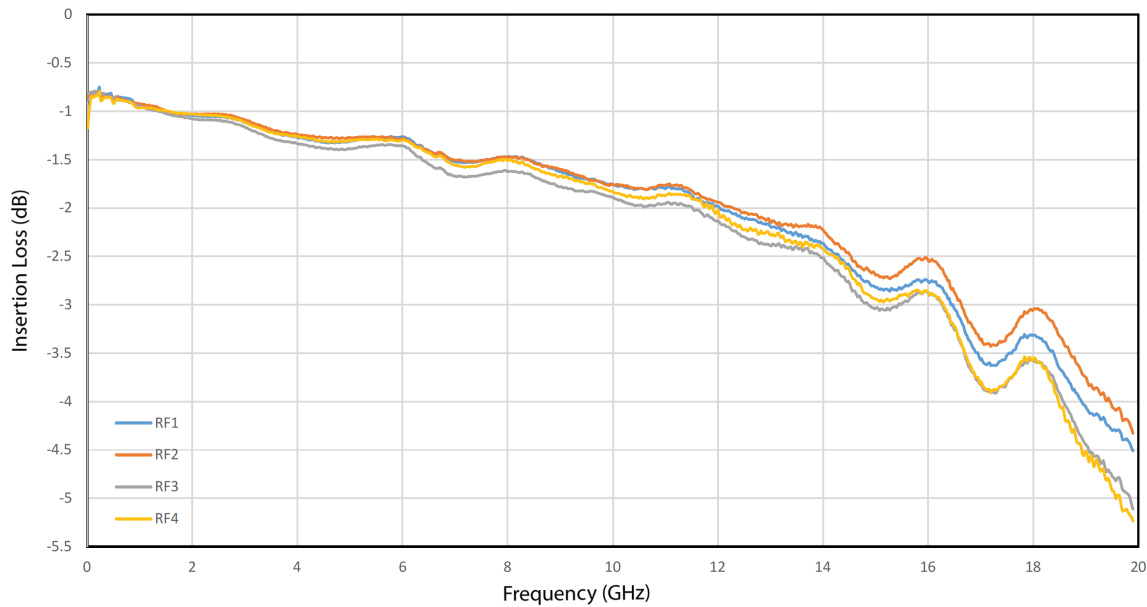


Figure 4. Insertion loss, RFC–RFx

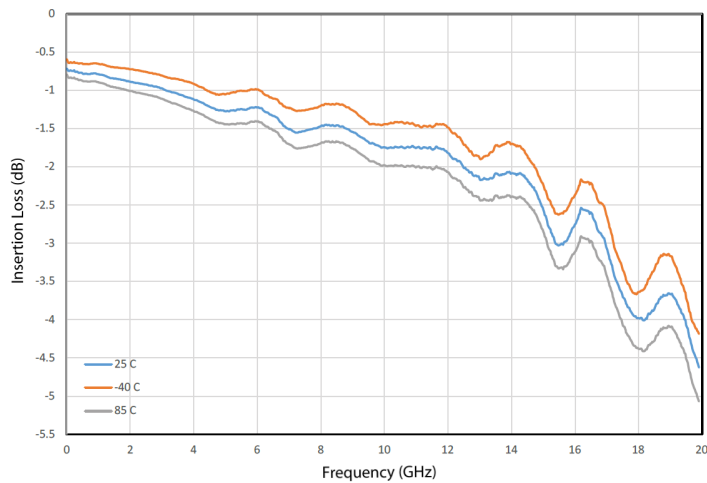


Figure 5. Insertion loss vs. temperature, RFC–RFx

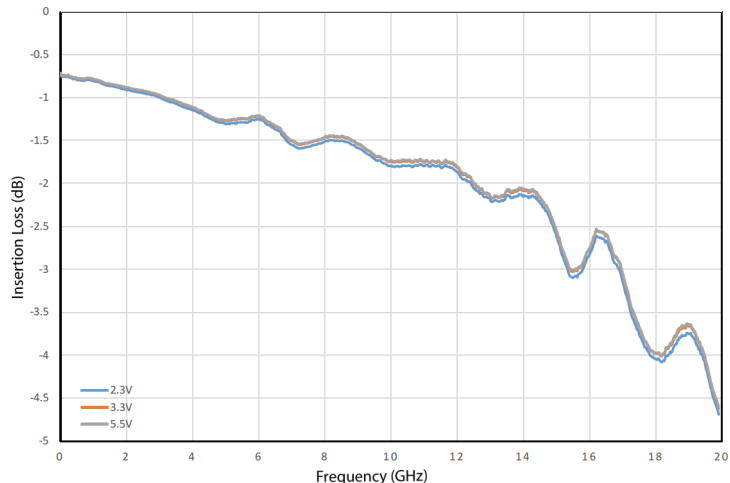


Figure 6. Insertion loss vs.  $V_{DD}$ , RFC–RFx



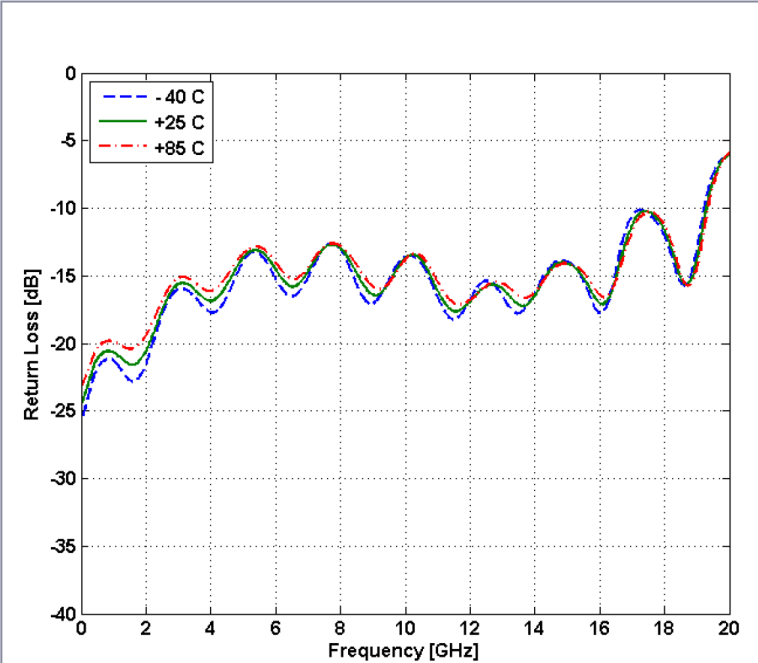


Figure 7. RFC port return loss vs. temperature

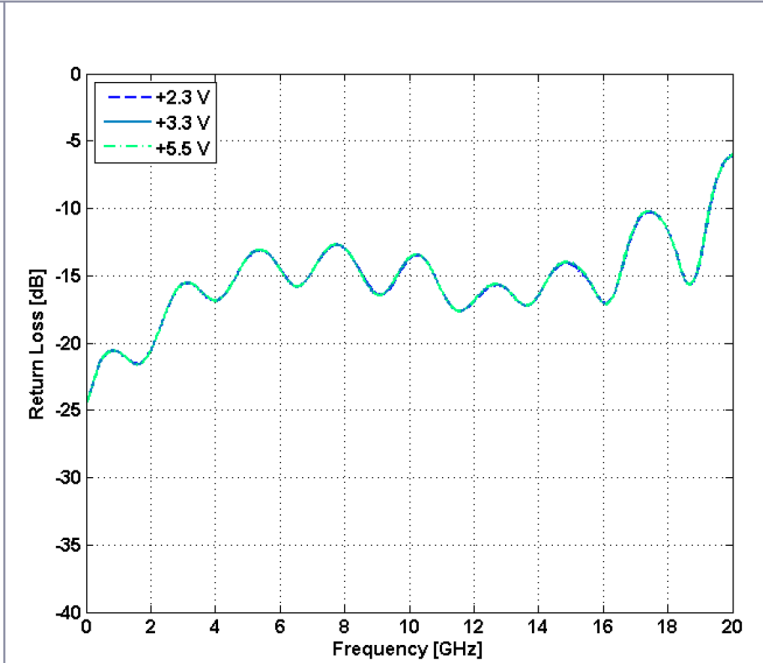


Figure 8. RFC port return loss vs.  $V_{DD}$

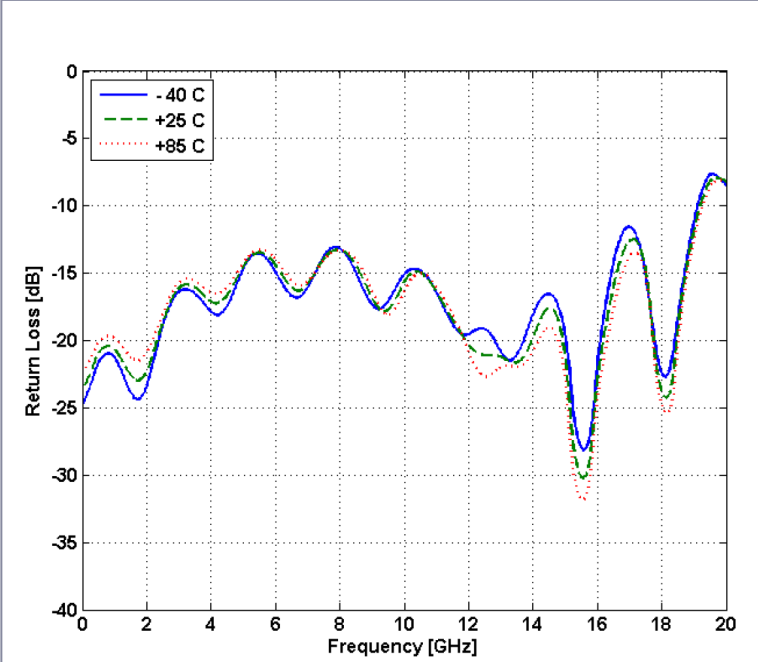


Figure 9. Active port return loss vs. temperature

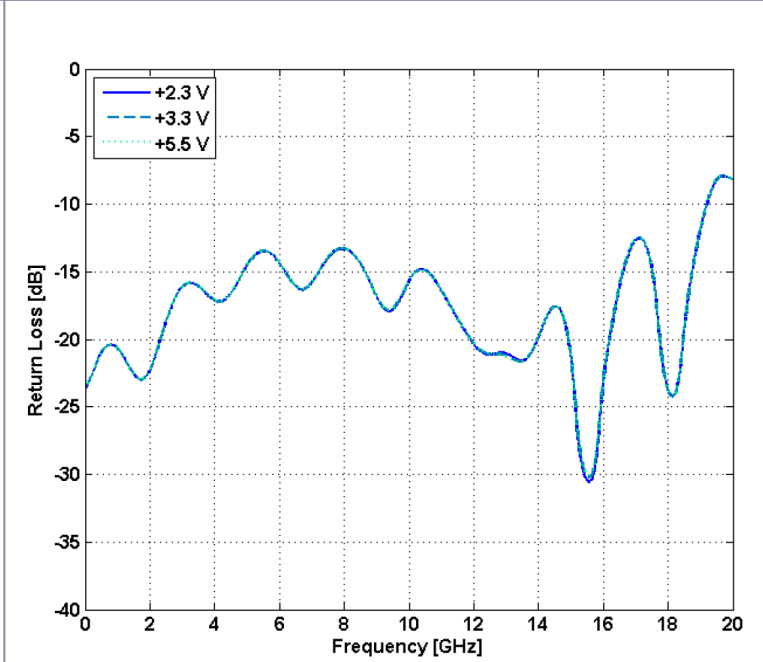
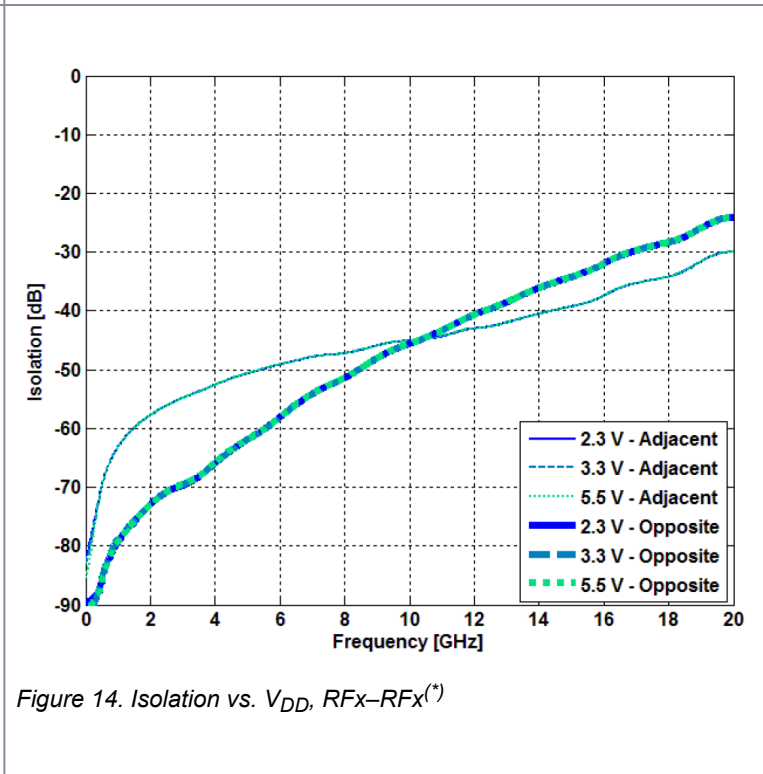
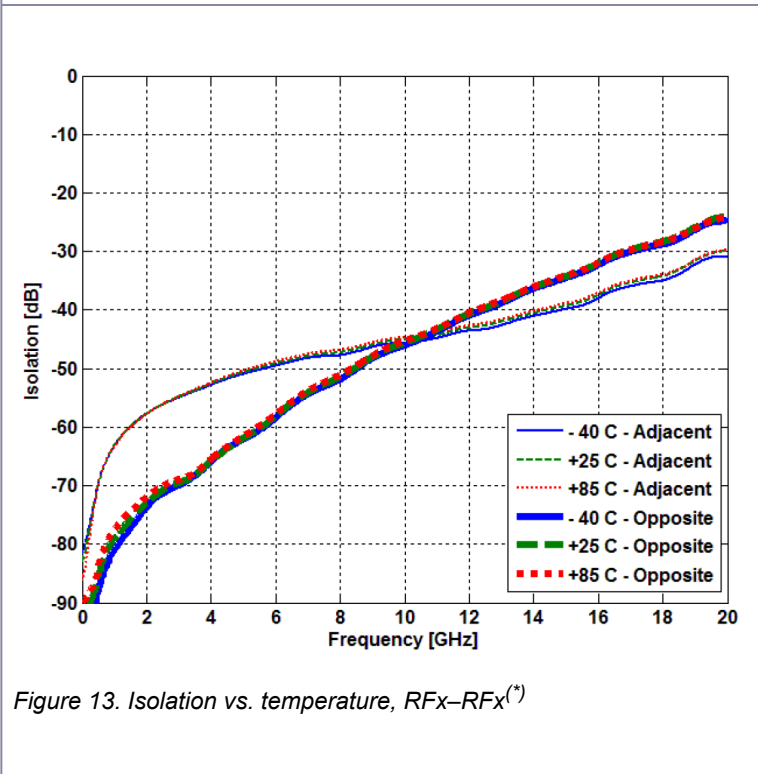
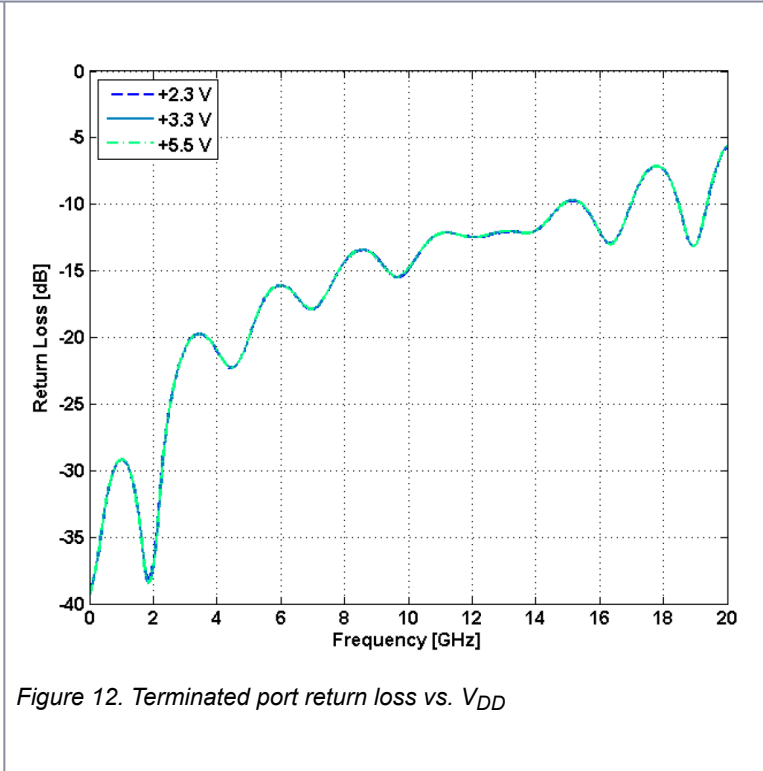
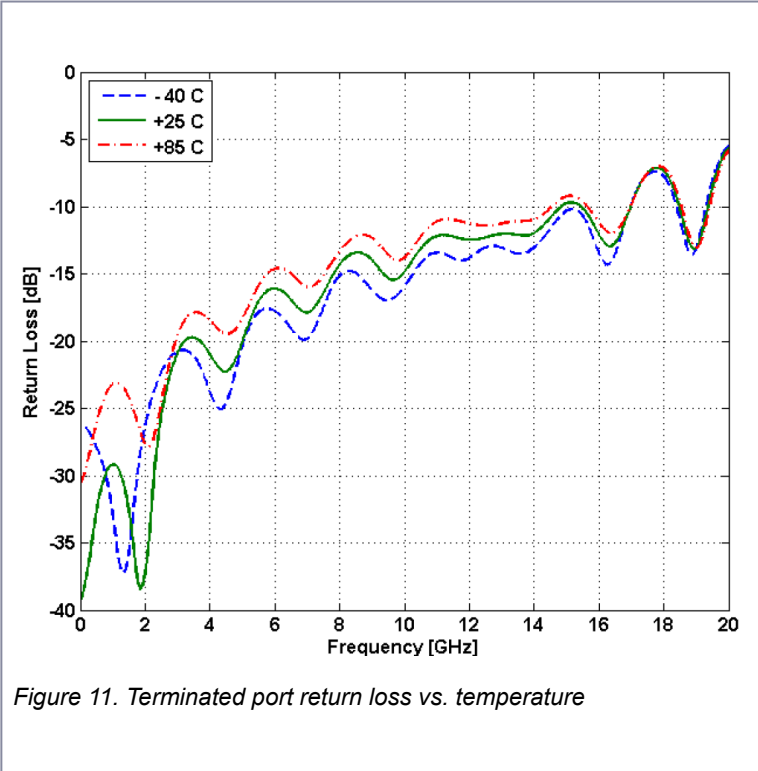


Figure 10. Active port return loss vs.  $V_{DD}$



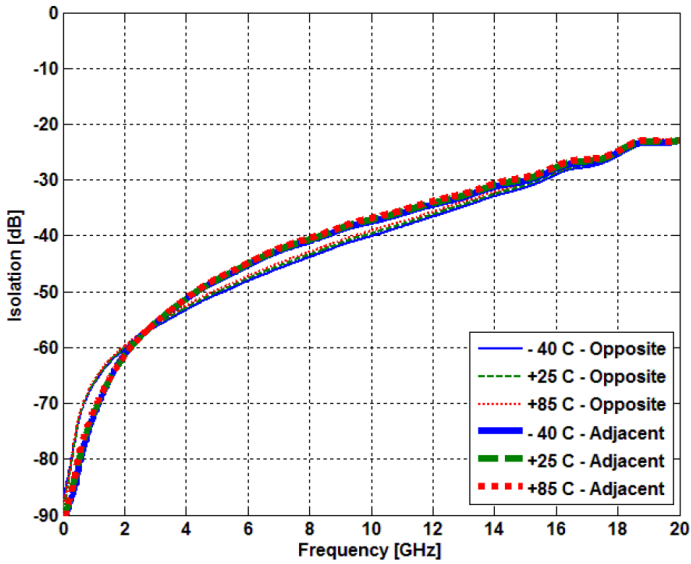


Figure 15. Isolation vs. temperature, RFC–RFx, RF1 or RF2 active(\*)

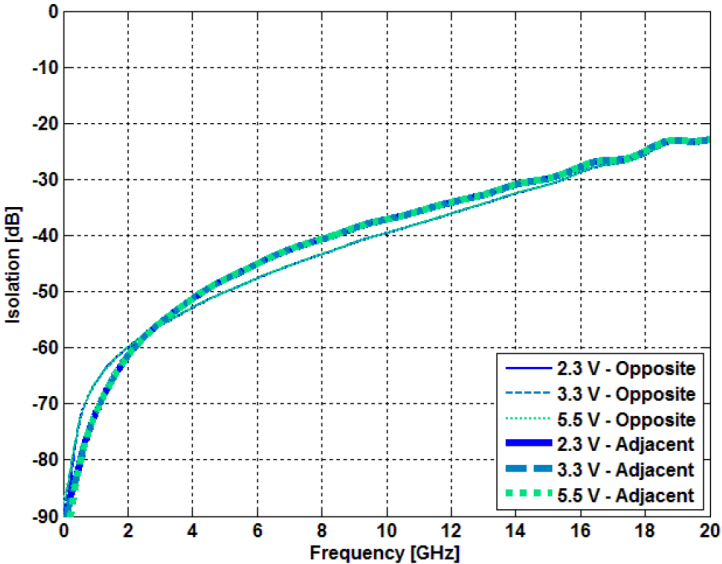


Figure 16. Isolation vs. V<sub>DD</sub>, RFC–RFx, RF1 or RF2 active(\*)

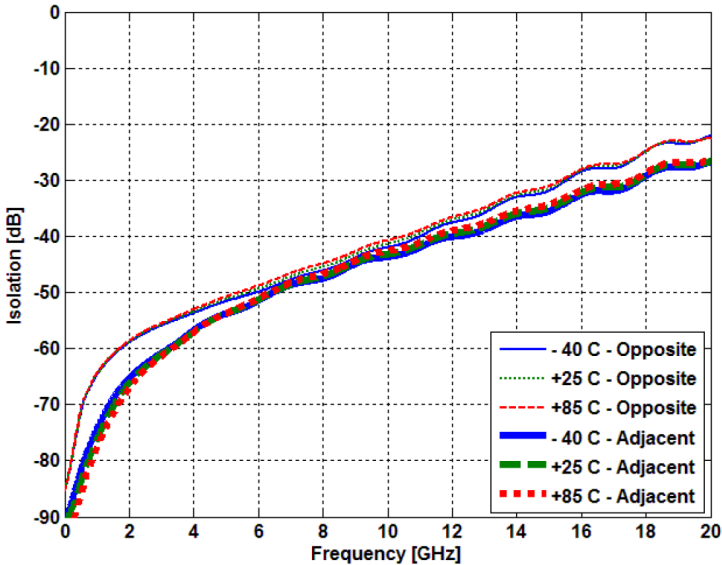


Figure 17. Isolation vs. temperature, RFC–RFx, RF3 or RF4 active(\*)

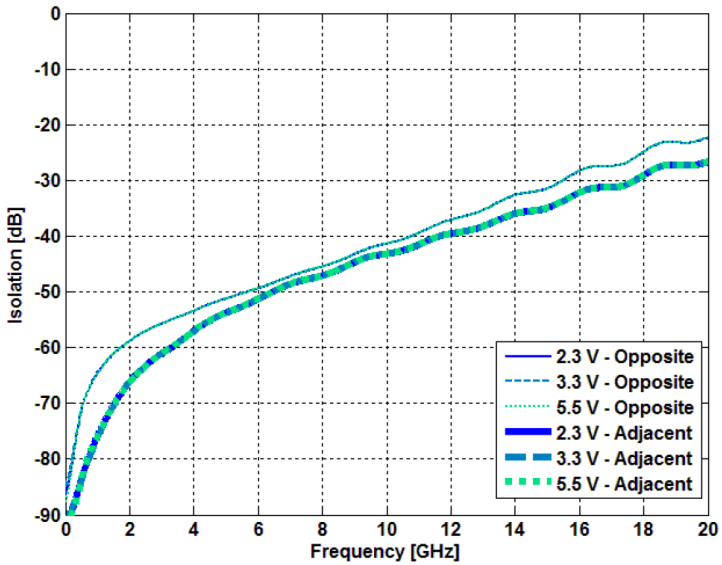


Figure 18. Isolation vs. V<sub>DD</sub>, RFC–RFx, RF3 or RF4 active(\*)

Note: \* RF1 is adjacent to RF3, RF2 is adjacent to RF4, and RF1 and RF3 are opposite RF2 and RF4.

## Evaluation kit

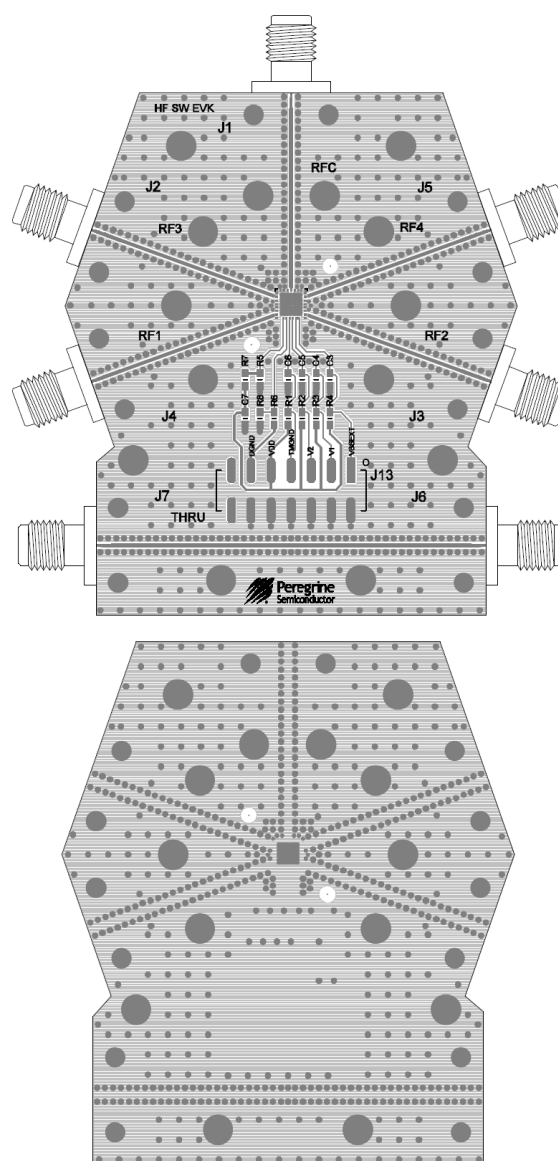
pSemi designed the SP4T switch evaluation board to help you evaluate the pSemi PE42542. The RF common port connects through a 50 $\Omega$  transmission line via the SMA connector, J1. Ports RF1, RF2, RF3, and RF4 connect through 50 $\Omega$  transmission lines via SMA connectors J4, J3, J2, and J5, respectively. A 50 $\Omega$  through transmission line is available via SMA connectors J6 and J7, which you can use to de-embed the loss of the PCB. J13 provides DC and digital inputs to the device.

The board is constructed of a four metal layer material with a total thickness of 62 mils. The top RF layer is Rogers 4360 material with a thickness of 32 mils and the  $\epsilon_r = 6.4$ . The middle layers provide ground for the transmission lines. The transmission lines were designed using a coplanar waveguide with a ground plane model using a trace width of 18 mils, trace gaps of 7 mils and metal thickness of 2.1 mils.

To realize the true performance of the PE42542, design the PCB so that the RF transmission lines and sensitive DC I/O traces are heavily isolated from one another.

High frequency insertion loss and return loss can be further improved by external series inductive tuning traces in the customer application board layout. For example, to improve the 12–18 GHz performance, use ~180 pH for the RFx ports and ~50 pH for the RFC port.

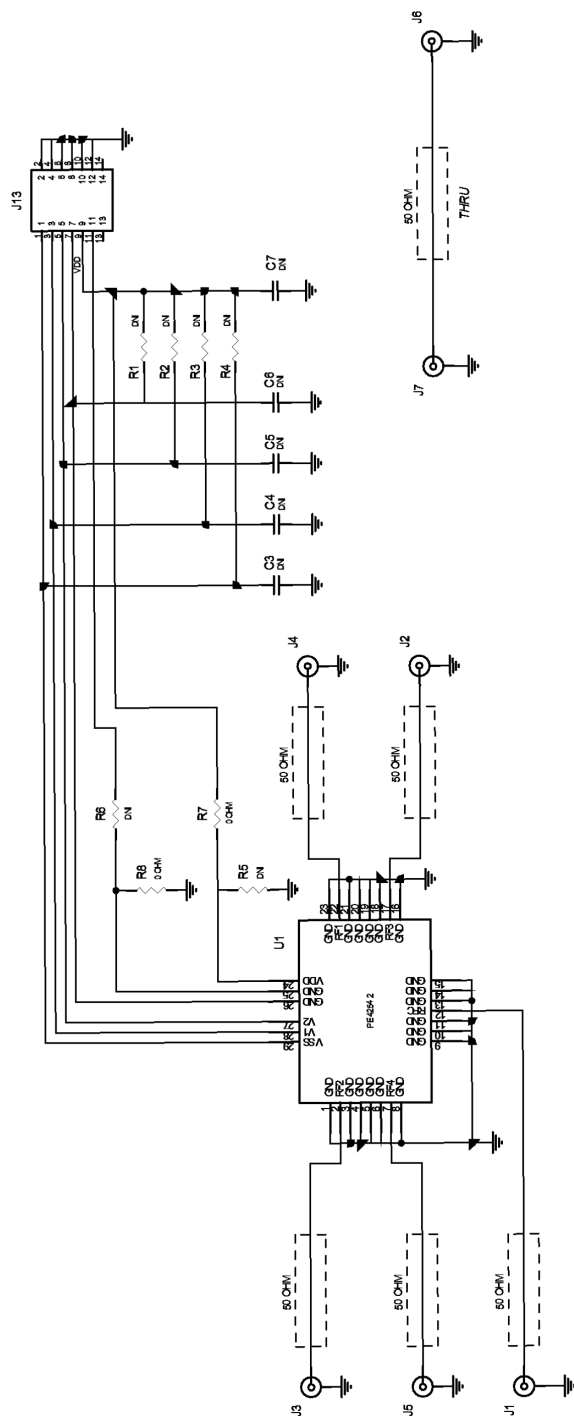
pSemi recommends using vector de-embed to accurately calculate the device under test (DUT) performance. For more information, see Application Note 39, [Vector De-embedding of the PE42542 and PE42543 SP4T RF Switches](#). To ease the vector de-embedding, download the [Half Fixture Thru File](#) from the pSemi website.



PRT-09205

Figure 19. Evaluation board layout

Evaluation board schematic



CAUTION: Contains parts and assemblies susceptible to damage by electrostatic discharge (ESD).

DOC-12227

Figure 20. Evaluation board schematic

Table 4. Pin descriptions

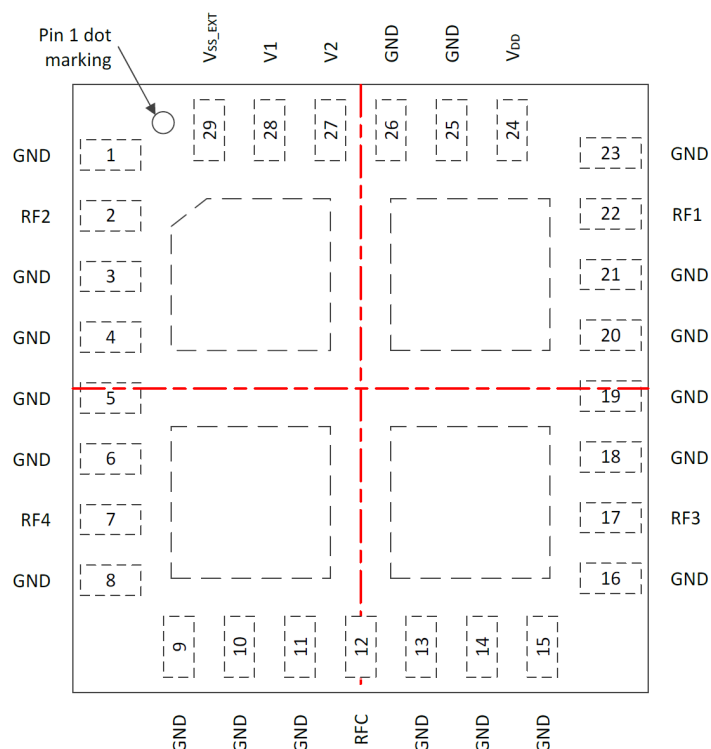


Figure 21. Pin configuration, top view

| Pin no.                                   | Pin name            | Description                           |
|-------------------------------------------|---------------------|---------------------------------------|
| 1, 3–6, 8–11, 13–16,<br>18–21, 23, 25, 26 | GND                 | Ground                                |
| 2 <sup>(1)</sup>                          | RF2                 | RF port 2                             |
| 7 <sup>(1)</sup>                          | RF4                 | RF port 4                             |
| 12 <sup>(1)</sup>                         | RFC                 | RF common                             |
| 17 <sup>(1)</sup>                         | RF3                 | RF port 3                             |
| 22 <sup>(1)</sup>                         | RF1                 | RF port 1                             |
| 24                                        | V <sub>DD</sub>     | Supply voltage (nominal 3.3V)         |
| 27                                        | V2                  | Digital control logic input 2         |
| 28                                        | V1                  | Digital control logic input 1         |
| 29 <sup>(2)</sup>                         | V <sub>SS_EXT</sub> | External VSS negative voltage control |
| Pad                                       | GND                 | Ground                                |

1. RF pins 2, 7, 12, 17, and 22 must be at 0 VDC. These RF pins do not require DC blocking capacitors for proper operation if the 0 VDC requirement is met.
2. Use  $V_{SS\_EXT}$  (pin 29) to bypass and disable the internal negative voltage generator. Connect  $V_{SS\_EXT}$  (pin 29) to GND ( $V_{SS\_EXT} = 0V$ ) to enable the internal negative voltage generator.

Packaging information

This section provides the following packaging data:

- Moisture sensitivity level
  - Package drawing
- Package marking
  - Tape-and-reel information

Moisture sensitivity level

The PE42542 moisture sensitivity level rating for the 29-lead 4 × 4 mm LGA package is MSL3.

Package drawing

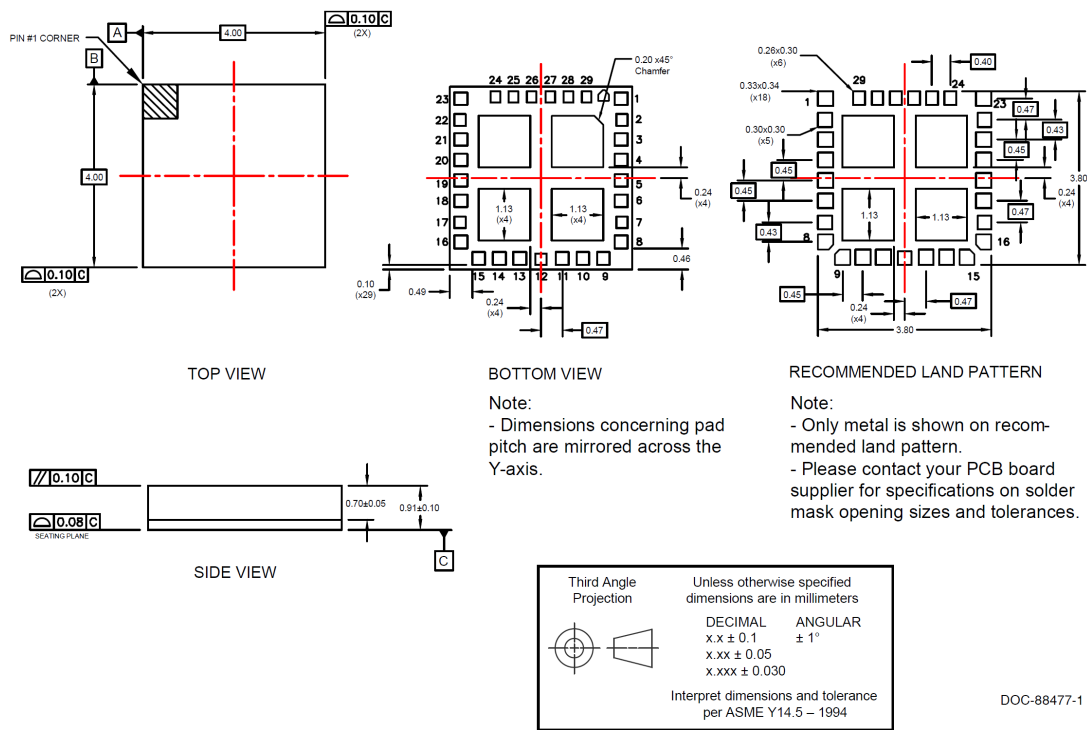


Figure 22. Package mechanical drawing for the 29-lead 4 × 4 mm LGA package

Top-marking specification

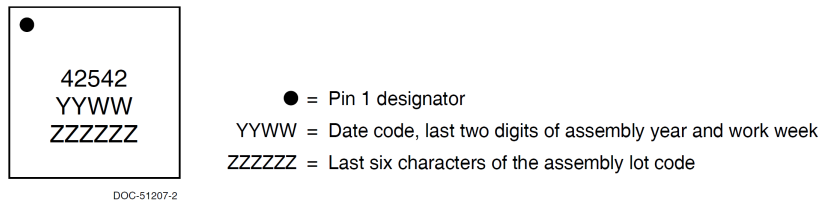


Figure 23. Package marking specification

Tape and reel specification

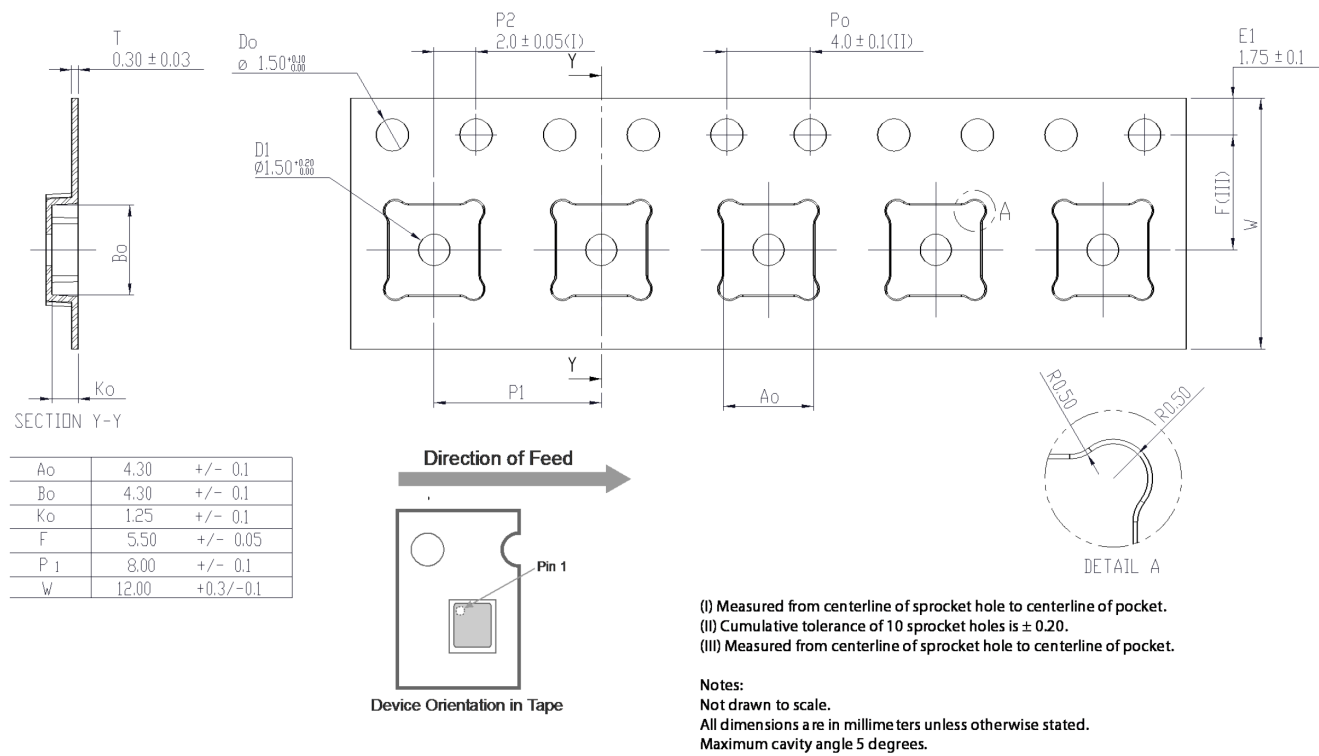


Figure 24. Tape and reel specification for the 29-lead 4 × 4 mm LGA package



## Ordering information

| Order code | Description            | Packaging            | Shipping method |
|------------|------------------------|----------------------|-----------------|
| PE42542C-X | PE42542 SP4T RF switch | 29-lead 4 × 4 mm LGA | 500 units/T&R   |
| EK42542-03 | PE42542 evaluation kit | Evaluation kit       | 1/box           |

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